Special Instructions: You must write your name and netid on every sheet of the exam.

ECE 340 –Fall 2015	Name Solutions
	Net ID#
	Section

ECE 340 – EXAM II Thursday November 5th, 2015 7:00 – 8:00 p.m.

100 Noyes Laboratory

Sections A (Feng), E (Bayram), X (Dallesasse)

314 Altgeld Hall Secti

Sections B (Zhu), D (Kim)

NOTE:

This is a closed book and closed notes exam. No calculators are allowed. The exam consists of five problems. Unless stated otherwise, do your work on the page of the problem and if necessary on the preceding blank page. Be sure to explicitly show the units in your work, as well as in your answers. Circle your answer. Be neat!

If we cannot read or follow your work, you get zero credit!

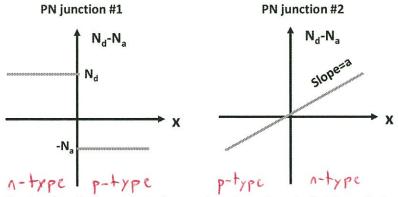
For each problem, you must show complete work and indicate your reasoning. No credit will be given if you do not show the complete work and describe your procedure, even if the answer is correct. Write your name, ID#, and section on this page and sign below.

	Prob	.#1	Prob.	#2	Prob	.#3	Prob	.#4	Pro	o.#5
	20 pt	ts.	20 pt	s.	20 pt	s.	20 p	ts.	20 p	ts.
a	10		7		7		7		6	
b	4		7		7		7		6	
С	6		6		6		6		8	
d										
e										
f										
g	1									
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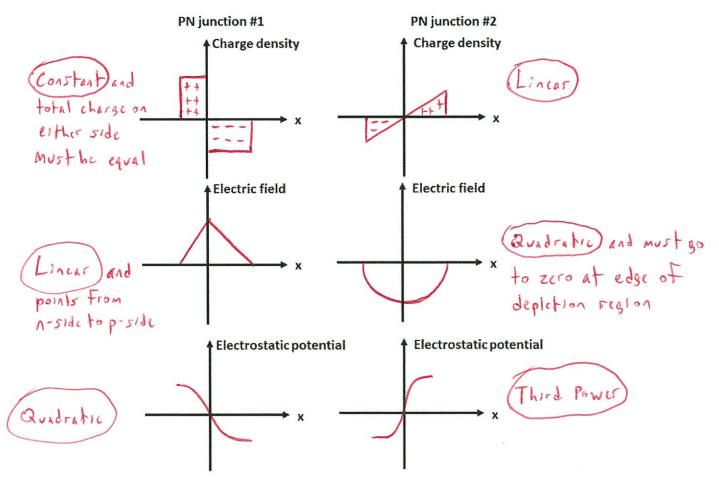
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1. pn Junctions at Equilibrium and Contact Potential

Consider two pn junctions with following doping profiles:



a) Please qualitatively sketch the space charge density, electric field, and electrostatic potential of these pn junctions. Please specify if they are constant, varying linearly, quadratically, to the third power, or exponentially with position x. Hint: Think about how these terms were derived. (10 pts)



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b) Use arrows to indicate the directions and relative magnitudes of the drift and diffusion currents in these pn junctions at equilibrium. (4 pts)

PN junction #1

PN junction #2

	Electron	Hole
Diffusion current	4	-
Drift current	-	-

	Electron	Hole
Diffusion current		
Drift current	-	4

Current Direction

Current Direction

c) Consider a pn junction with doping concentration N_d in n type region, N_a in p type region, and a contact potential V_0 . Which of following changes will increase the contact potential (choose all options that may apply)? Please explain why you choose these options. (6 pts)

i) Increase the donor doping concentration N_d in the n type material.

ii) Reduce the acceptor doping concentration N_a in the p type material.

(iii) Increase the bandgap of the p and n material, while keeping N_d and N_a the same.

(iv) Decrease the temperature.

i)
$$V_0 = \frac{kT}{q} \ln \left(\frac{N_A N_D}{\Lambda_i^2} \right)_1$$
 if N_D increases then V_0 increases

- By the equation in (i), if ni decreases and NA and ND remain the same, Vo increases
 - iv) A decrease in temperature results in a decrease in ni. Even iF carrier Freeze out is taken into effect, Efp approaches Ev as T-10 on the p-side and Efn approaches Ec as T-10 on the n-side. Since qVo = (Efn-Ei) + (Ei-Efp), Vo increases

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2. pn Junction Electrostatics

A semi-infinite abrupt n^+ - p junction has the n-side 9 times more heavily doped than the p-side. For this device the contact potential V_0 is 0.8V and the depletion region width W_0 at equilibrium is 260 nm.

Please answer the following questions:

a) What is the extension (i.e., length) of the depletion region on each side of the junction at equilibrium? Note: You should be able to calculate the values. (7 pts)

$$W_{0} = X_{n_{0}} + X_{p_{0}} = X_{n_{0}} + X_{n_{0}} \left(\frac{N_{0}}{N_{A}}\right) = 10 X_{n_{0}}$$

$$X_{n_{0}} = \frac{W_{0}}{10} = 260 \text{ nm}$$

$$X_{p_{0}} = \frac{9}{10} W_{0} = 234 \text{ nm}$$

b) What is the maximum electric field strength \mathcal{E}_0 within the depletion region? Note: Write an expression in the simplest possible form. (7 pts)

$$\frac{1}{2} \text{ W}_{0} \stackrel{?}{E}_{0} = \text{V}_{0}$$

$$\Rightarrow \stackrel{?}{E}_{0} = \frac{2 \text{ V}_{0}^{*} \text{ O.8V}}{\text{W}_{0}} = \frac{1.6 \text{ V}}{260 \text{ nm}} = \frac{1.6 \text{ V}}{2.6 \cdot 10^{-7} \text{ m}}$$

$$= 6.15 \cdot 10^{6} \stackrel{?}{\text{V}_{m}}$$

$$= 6.15 \cdot 10^{6} \stackrel{?}{\text{V}_{m}}$$

$$1.3 | 80.$$

$$\frac{78}{20}$$

$$\frac{13}{70}$$

$$\frac{13}{70}$$

$$\frac{13}{70}$$

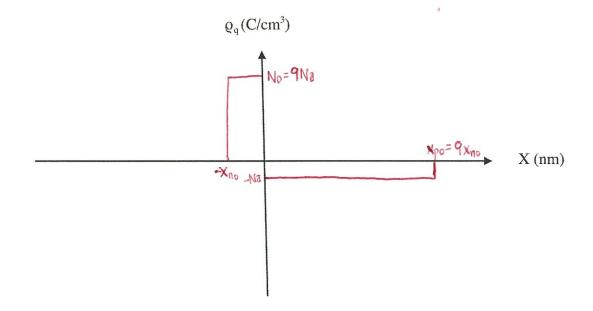
$$\frac{13}{70}$$

$$\frac{13}{70}$$

$$\frac{13}{70}$$

$$\frac{13}{70}$$

c) Plot the space charge distribution within the depletion region of the n^+ - p junction. Assume that donors (N_d) and acceptors (N_a) are fully ionized and that N_a is known. (6 pts)



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3. Injection and Currents in pn Junctions

Assume that we have a silicon diode with n-doping of 10^{17} cm⁻³ and p-doping of 10^{17} cm⁻³. If we increase the n-doping to 10^{19} cm⁻³ and p-doping to 10^{19} cm⁻³;

a) What would happen to the <u>magnitude</u> of the reverse-bias saturation current? Circle one ONLY. Explain briefly. (7 pts)

DECREASE

STAY SAME

1

When in reverse bias, I depends on minority exercise concentration alone.

$$\overline{J}_{S} = q \left(\frac{D_{P}}{L_{P}} p_{n} + \frac{D_{n}}{L_{n}} n_{P} \right) = q \left(\frac{L_{P}}{\epsilon_{P}} p_{n} + \frac{L_{n}}{\epsilon_{n}} n_{P} \right)$$

since ppt, $n_n t$, $p_{n_n t} = \frac{n_1^2}{n_n t}$ where $n_n = N_D(\text{increasing})$

$$n_{p} \downarrow = \frac{n_{i}^{2}}{P_{p} \uparrow}$$
 where $p_{p} = N_{A} (m \text{ creasing})$

therefore, $|Js| = q \left(\frac{Lp}{zp} p_n + \frac{Ln}{z_n} n_p + \right)$

so the magnitude of Isat reduces, meaning Isat decreases for a constant volume.

b) What would happen to the <u>magnitude</u> of the breakdown voltage? Circle one ONLY. Explain briefly. (7 pts)

INCREASE

DECREASE

STAY SAME

Since W of NAND, we know that an increase in doping will decrease our depletion width.

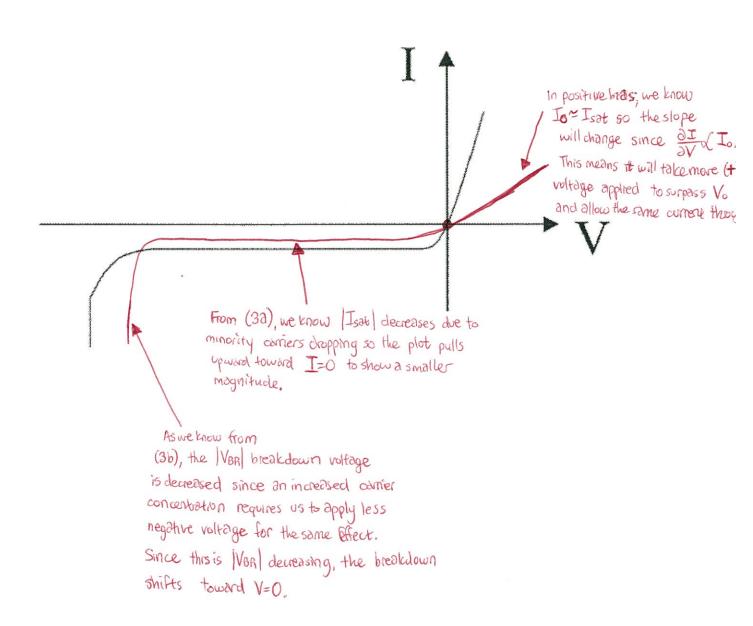
Since doping increases, we can expect the Exp and Exp to separate more so from p-side to n-side, causing Vo to increase,

Breakdown voltage will be decreased as we increase the concentration of holes and electrons, for the Zener effect will more readily cause tunneling since the depletion width is reduced and Vo is increased, allowing corners to slip across a thinner barner. Thus, we need less applied voltage, "VBR, to align the bands for a Zener breakdown.

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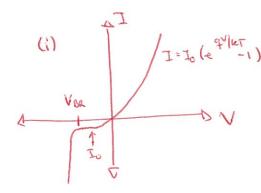
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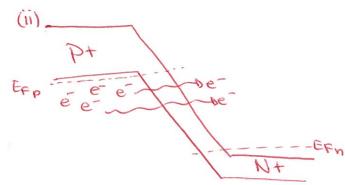
c) The following shows the current-voltage plot of the silicon diode with n-doping of 10^{17} cm⁻³ and p-doping of 10^{17} cm⁻³. Show your approximation of the current-voltage for a silicon diode with n-doping of 10^{19} cm⁻³ and p-doping of 10^{19} cm⁻³ on the same plot. Explain your reasons. (6 pts)



4. Reverse Bias with Breakdown and Junction Capacitance

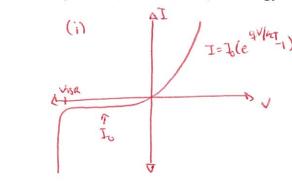
a) Draw i) an I-V and ii) an energy band diagram and explain Zener breakdown. (7 pts)

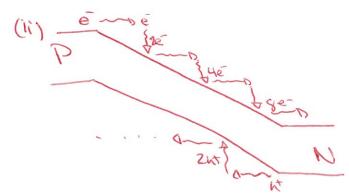




(iii) Electron on p-side turneling to n-side conduction band to provide breakdown current

b) Draw i) an I-V and ii) an energy band diagram and explain Avalanche breakdown. (7 pts)





VBR(N) > VBR(Z)

(iii) Low doping so large depletion width with high electric field causes comiers to how high kinetic energy. LE high enalsh for impact tonization, carriers multiply and provide breakdown cerners.

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c) Given 3 silicon diodes – a p⁺n⁺ diode, a p⁺n diode, and a pn diode ("+" indicates heavy doping), list the diodes in order from greatest reverse-bias capacitance to smallest reverse-bias capacitance. Assume that the n-doping level is the same for the second two diodes. Explain your answer. Avoid circular arguments. (6 pts)

leurse bias capacitance is junction capacitance, given as $C = \frac{EA}{W} \quad \text{while } W \text{ is depletion width.}$

Higher doping gives smaller depletion width, so

ptnt & smallest W & highest C

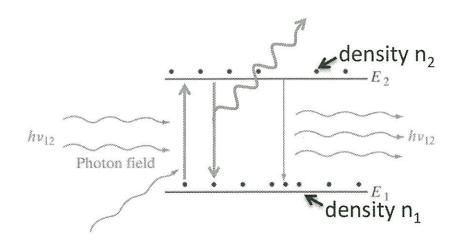
ptn & middle W & middle C

pn & targest W & smallest C

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5. Optoelectronic Devices

Consider a two-state system as depicted below:



a) What terminology (i.e. absorption, etc.) is used to describe the following rates (6 pts):

i)
$$B_{21}n_2\rho(v_{12})$$

Terminology: Stimulated emission

ii)
$$B_{12}n_1\rho(v_{12})$$

Terminology: Absorption

iii)
$$A_{21}n_2$$

Terminology: Sportaneous emission

b) Write an expression that relates these terms in steady state. (6 pts)

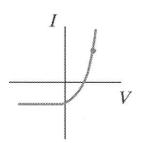
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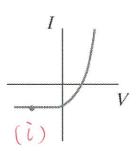
c) In the following diagrams, label the following curves or points:

- i) I-V showing operating point for typical photodiode operation. (2 pts)
- ii) I-V showing operating point for typical solar cell operation. (2 pts)
- iii) Short circuit current I_{sc} (on solar cell I-V). (2 pts)
- iv) Open circuit voltage Voc (on solar cell I-V). (2 pts)

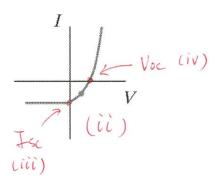
1st quadrant



3rd quadrant



4th quadrant



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Useful Formulae

$$N_{C} = 2 \left(\frac{2\pi m_{n}^{*} kT}{h^{2}} \right)^{3/2}$$

$$N_{V} = 2 \left(\frac{2\pi m_{p}^{*} kT}{h^{2}} \right)^{3/2}$$

$$E = -\nabla V$$

$$= \frac{1}{q} \frac{dE_c}{dx} = \frac{1}{q} \frac{dE_v}{dx} = \frac{1}{q} \frac{dE_i}{dx}$$

$$V = -\frac{1}{q} \left(E_c - E_{ref} \right)$$

$$J_n(x) = q\mu_n n(x)E(x) + qD_n \frac{dn(x)}{dx}$$

$$J_{p}(x) = q\mu_{p}n(x)E(x) - qD_{p}\frac{dp(x)}{dx}$$

$$-\frac{d^2\mathcal{V}(x)}{dx^2} = \frac{d\mathcal{E}(x)}{dx} = \frac{\rho(x)}{\varepsilon}$$

$$\rho(x) = q(p(x) - n(x) + N_d^+(x) - N_a^-(x))$$

$$W = \left[\frac{2\varepsilon (V_0 - V)}{q} \left(\frac{N_a + N_d}{N_a N_d} \right) \right]^{1/2}$$

$$\Delta p_n = p(x_{n0}) - p_n = p_n \left(e^{qV/kT} - 1 \right)$$

$$\begin{split} J_0 &= q \left(\frac{D_P}{L_P} p_n + \frac{D_n}{L_n} n_p \right) = q \left(\frac{L_p}{\tau_p} p_n + \frac{L_n}{\tau_n} n_p \right) \\ n + N_A^- &= p + N_D^+ \end{split}$$

$$np = n_i^2$$

$$J_0 = \frac{I_0}{A}$$

$$J_0 = \frac{I_0}{A}$$

$$J_n^{drift} = -qn\langle v_{dn} \rangle = qn\mu_n E$$

$$\frac{D_N}{\mu_N} = \frac{k_b T}{q}$$

$$\frac{D_P}{\mu_P} = \frac{k_b T}{q}$$

$$\rho = \frac{1}{\sigma} = \frac{1}{q(n\mu_n + p\mu_p)}$$

$$n = N_c e^{\frac{(E_f - E_c)}{k_b T}}$$

$$p = N_{v}e^{\frac{\left(E_{v} - E_{f}\right)}{k_{b}T}}$$